



InGaAs linear image sensors

G13913 series

Near infrared image sensors for portable analytical instruments

The compact low-cost near infrared linear image sensors are designed for portable analytical instruments. They consume less current than the previous product (DIP package products: G11620 series). They are suitable for integration into compact thin devices because they employ a compact LCC package with a flexible board.

Features Compact (with flexible board) ■ 3.3 V drive **■ Low current consumption: 15 mA (G13913-128FB)** → Low cost 128 pixels (50 μm × 250 μm/pixel): G13913-128FB 256 pixels (25 μ m \times 250 μ m/pixel): G13913-256FG **■** Selectable from two conversion efficiency levels ■ Built-in anti-saturation circuit ■ Easy operation (built-in timing generator*1) → High resolution: 25 µm pitch (G13913-256FG)

Portable analytical instruments

Structure

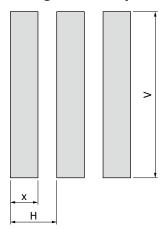
Parameter	G13913-128FB	G13913-256FG	Unit	
Image size	6.4 ×	: 0.25	mm	
Pixel size (H × V)	50 × 250	25 × 250	μm	
Pixel pitch	50	25	μm	
Total number of pixels	128	256	pixels	
Number of effective pixels	128	256	pixels	
Package	Ceramic with flexible board			
Window material	Borosilicate glass*2 (no anti-reflective coating)			
Cooling	Non-cooled			

^{*2:} Windowless types are also available.

Applications

^{*1:} Previously, multiple timing signals were applied using external PLD (programmable logic device) or the like to run the shift register. This image sensor has a built-in CMOS circuit for timing generation. All timing signals are generated inside the image sensor by simply applying CLK and RESET signals.

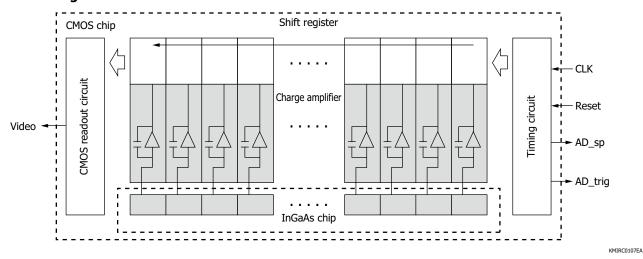
- Enlarged view of photosensitive area (unit: μm)



Type no.	х	Н	V
G13913-128FB	30	50	250
G13913-256FG	10	25	250

KMIRC0106EA

Block diagram



- Absolute maximum ratings

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Supply voltage	Vdd, INP, Fvref Vhold, PDN	Ta=25 °C	-0.3	-	+4.2	V
Clock pulse voltage	·	Ta=25 °C	-0.3	-	+4.2	V
Reset pulse voltage	V(RES)	Ta=25 °C	-0.3	-	+4.2	V
Gain selection terminal voltage	Vcfsel	Ta=25 °C	-0.3	-	+4.2	V
Operating temperature	Topr	No dew condensation*3	-10	-	+60	°C
Storage temperature	Tstg	No dew condensation*3	-20	-	+70	°C

^{*3:} When there is a temperature difference between a product and the surrounding area in high humidity environment, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.

Note: Absolute maximum ratings indicate values that must not be exceeded. Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.



➡ Recommended terminal voltage (Ta=25 °C)

Parameter	Parameter Symb		Min.	Тур.	Max.	Unit
Supply voltage		Vdd	3.0	3.3	3.6	V
Differential reference vo	ltage	Fvref	2.4	2.5	2.6	V
Sample hold voltage		Vhold	2.4	2.5	2.6	V
Input stage amplifier refe	rence voltage	INP	2.4	2.5	2.6	V
Photodiode cathode voltage		PDN	2.4	2.5	2.6	V
Ground		GND	-	0	-	V
Clock pulse voltage	High	Vclk	Vdd - 0.25	Vdd	Vdd + 0.25	V
Low		VCIK	-	0	+0.25	
Reset pulse voltage	High	V(RES)	Vdd - 0.25	Vdd	Vdd + 0.25	V
Neset puise voltage	Low	V(NLS)	-	0	+0.25	V

➡ Electrical characteristics (Ta=25 °C)

Parameter	Parameter		Min.	Тур.	Max.	Unit
		G13913-128FB	-	15	25	
		G13913-256FG	-	20	30	
Current consumption		Ifvref	-	-	1	
Current consumption		Ivhold	-	-	1	— mA
		Iinp	-	-	1	
		Ipdn	-	-	1	
Clock frequency		fop	0.1	1	2	MHz
Data rate	Data rate		-	fop	-	MHz
\/:daa_autout valtaaa	Dark	Vdark	-	2.5	2.9	V
Video output voltage Saturati		Vsat	0.2	0.3	-	v
Output offset voltage		Vos	-	Fvref	-	V
Output impedance		Zo	-	6	-	kΩ
AD_trig, AD_sp	AD_trig, AD_sp High		-	Vdd	-	V
Pulse voltage	Low	Vtrig, Vsp	-	GND	-	v

■ Electrical and optical characteristics (Ta=25 °C, Vdd=3.3 V, INP=Fvref=Vhold=PDN=2.5 V, Vclk=3.3 V, fop=1 MHz)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Spectral response range	λ	Containen	-	0.95 to 1.7	-	μm
Peak sensitivity wavelength	λр		-	1.55	-	μm
Photosensitivity	Š	λ=λρ	0.7	0.82	-	A/W
Conversion efficiency*4	CE	Cf=10 pF	-	16	-	nV/e⁻
Conversion eniciency	C	Cf=1 pF	-	160	-	liv/e
Photoresponse nonuniformity*5	PRNU	CE=16 nV/e-	-	±5	±10	%
Saturation charge	Cook	CE=16 nV/e-	125	137.5	-	- Me-
	Csat	CE=160 nV/e-	12.5	13.75	-	
Saturation output voltage	Vsat	t=20 ms	2.0	2.2	-	V
Dark output	VD	CE=16 nV/e ⁻	-	±0.1	±1	V/s
Dark current	ID	CE=16 nV/e ⁻	-	±1	±10	pА
Temperature coefficient of dark output (dark current)	-		-	1.1	-	times/°C
Readout noise*6	Nread	CE=16 nV/e-	-	150	400	uV rms
	Meau	CE=160 nV/e-	-	300	500	μντιτις
Dynamic range	Drange	CE=16 nV/e ⁻	5000	14667	-	-
Defect pixels*7	-	CE=16 nV/e ⁻	-	-	1	%

^{*4:} For switching the conversion efficiency, see the pin connections.

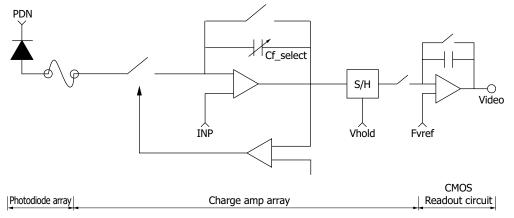


^{*5:} Measured at 50% saturation and 10 ms integration time after subtracting the dark output, excluding the first and last pixels

^{*6:} Integration time when CE=16nV/e⁻ is 10 ms. Integration time when CE=160 nV/e⁻ is 1 ms.

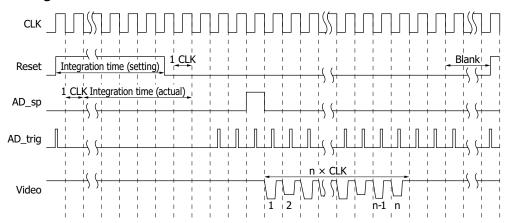
^{*7:} Pixels whose photoresponse nonuniformity, readout noise, or dark current is outside the specifications

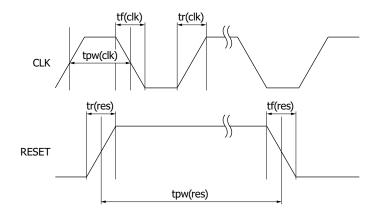
Equivalent circuit



KMIRC0108EA

Timing chart



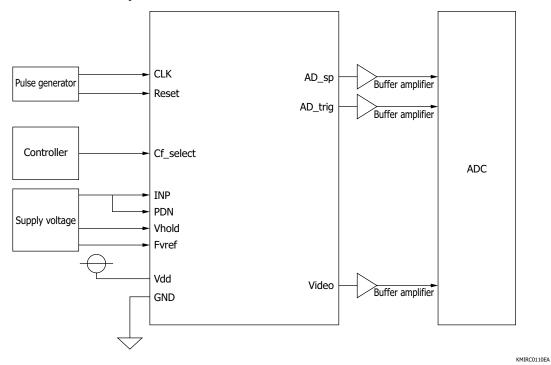


Note: n=number of channels

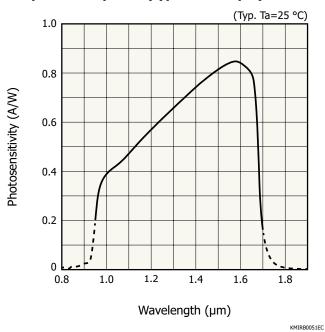
KMIRC0109EB

Parameter		Symbol	Min.	Тур.	Max.	Unit
Clock pulse frequency		fop	0.1	1	2	MHz
Clock pulse width		tpw(clk)	150	-	5000	ns
Clock pulse rise/fall times	3	tr(clk), tf(clk)	0	20	30	ns
Reset pulse width	High	tpw(res)	2	-	-	clocks
Reset puise width	Low	tpw(res)	Number of pixels + 16	-	-	CIOCKS
Reset pulse rise/fall times	5	tr(res), tf(res)	0	20	30	ns

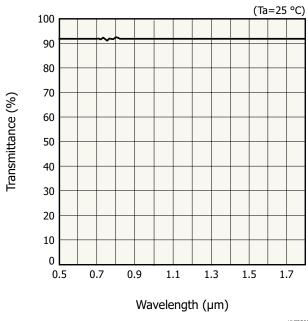
Connection example



Spectral response (typical example)

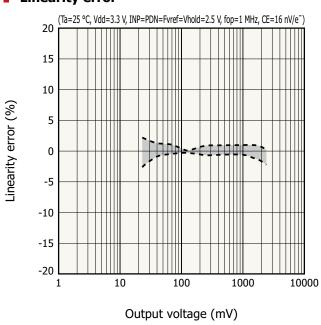


Spectral transmittance of window material (typical example)



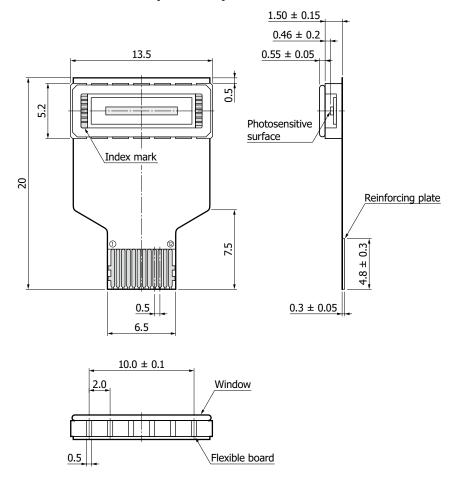
KMIRB0058E

Linearity error



KMIRB0107EA

Dimensional outline (unit: mm)



1	AD_trig	7	Fvref
2	GND	8	Video
3	AD_sp	9	PDN*
4	Vhold	10	INP*
5	CLK	11	Vdd
6	Reset	12	Cf_select

Tolerance unless otherwise noted: ± 0.25 Window refractive index: 1.47 Window thickness: 0.55 ± 0.05 Window sealing method: Resin adhesion Center position accuracy of photosensitive area $-0.3 \le X \le +0.3$ $-0.3 \le Y \le +0.3$ $-2^{\circ} \le \theta \le +2^{\circ}$

KMIRA0036ED

Pin connections

Terminal name	Input/output	Function and recommended connection	Note
PDN	Input	InGaAs photodiode's cathode bias terminal. Set to the same potential as INP.	2.5 V
AD_sp	Output	Digital start signal for A/D conversion	0 to 3.3 V
Cf_select	Input*8	Signal for selecting the feedback capacitance (integration capacitance) on the CMOS chip	0 to 3.3 V
AD_trig	Output	Sampling sync signal for A/D conversion	0 to 3.3 V
Reset	Input	Reset pulse for initializing the feedback capacitance in the charge amplifier formed on the CMOS chip. Integration time is determined by the high level period of this pulse.	0 to 3.3 V
CLK	Input	Clock pulse for operating the CMOS shift register	0 to 3.3 V
INP	Input	Input stage amplifier reference voltage. This is the supply voltage for operating the signal processing circuit on the CMOS chip. Set to the same potential as PDN.	2.5 V
Vhold	Input	Reference voltage for sample-and-hold circuit. This is the supply voltage for operating the signal processing circuit on the CMOS chip.	2.5 V
Fvref	Input	Differential amplifier reference voltage. This is the supply voltage for operating the signal processing circuit on the CMOS chip.	2.5 V
Video	Output	Differential amplifier output. This is an analog video signal. Nagative polarity.	0.3 to 2.5 V
Vdd	Input	Supply voltage for operating the signal processing circuit on the CMOS chip (+3.3 V)	3.3 V
GND	Input	Ground for the signal processing circuit on the CMOS chip (0 V)	0 V

^{*8:} The conversion efficiency is determined by the supply voltage to the Cf_select terminal as follows.

Conversion efficiency	Cf_select
16 nV/e- (low gain)	Low
160 nV/e ⁻ (high gain)	High

Low: 0 V (GND), High: 3.3 V (Vdd)

Electrostatic countermeasures

This device has a built-in protection circuit against static electrical charges. However, to prevent destroying the device with electrostatic charges, take countermeasures such as grounding yourself, the workbench and tools. Also protect this device from surge voltages which might be caused by peripheral equipment.

Related information

www.hamamatsu.com/sp/ssd/doc_en.html

- Precautions
- Disclaimer
- · Safety consideration / Opto-semiconductors
- · Precautions / Image sensors
- Catalogs
- · Selection guide / InGaAs image sensors
- · Technical note / InGaAs linear image sensors

Information described in this material is current as of August 2025.

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